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TOOLLESS PRINTED CIRCUIT CARRIER ASSEMBLY

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BACKGROUND OF THE INVENTION

[0001] Information storage devices are fundamental building blocks in computing, communications, and data storage. A common information storage device is a hard disk drive, or hard drive, that can generally store large data quantities and enable fast read and write access to stored data. A hard drive stores data on one or more magnetic storage platters that are rotated by a spindle motor using multiple read/write heads. Signals read or written by the head are amplified by one or more preamplifiers. Hard drive internal components are encased in a housing assembly with a cover, and are sealed tightly in a clean room environment. The drive also contains a printed circuit assembly (PCA). The printed circuit assembly houses drive electronics that enable the hard drive to communicate with a processor or controller, and enables synchronous operation of the hard drive components. PCA electronics commonly include a microprocessor that controls drive functions, interface electronics for communicating with the processor's interface bus, a controller application-specific integrated circuit (ASIC) that operates all controller hardware for the drive, a read channel to encode and decode data, and a motor ASIC to drive the motor and actuator coil.

[0002] As technology progresses, hard drives have increased density even while storing larger data quantities at greater access speed. The increased density of hard drives, and in electronic devices in general, has made assembly and maintenance more difficult. The difficulty of handling and accessing tiny components and devices can increase the time for production and servicing, thereby increasing costs. A particular challenge is the handling and manipulation of tiny hardware, such as screws, that are used to secure parts of electronic devices. Manipulation of tools to engage the hardware

increases time and costs of production and maintenance, whether tasks are performed manually or robotically.

SUMMARY

[0003] What are desired are structures and components, and associated operating methods, that enable toolless service, and maintenance of electronic devices.

[0004] According to an embodiment of the disclosed apparatus, a printed circuit assembly carrier comprises a carrier frame configured to hold a selected printed circuit assembly of at least two different printed circuit assemblies in at least two different orientations, a first toolless retention feature coupled to a first surface of the carrier frame and configured to retain the first printed circuit assembly, and a second toolless retention feature coupled to a second surface of the carrier frame configured to retain the second printed circuit assembly in at least one of the orientations.

[0005] In accordance with other embodiments, an electronic device assembly comprises a housing, first and second printed circuit assemblies of respective first and second types capable of coupling to the housing, and a plurality of identical printed circuit assembly carriers capable of coupling the first and second printed circuit assemblies to the housing. The carriers couple the printed circuit assemblies of different types to the housing in different orientations via toolless retention features.

[0006] In accordance with additional embodiments, a method of assembling and/or configuring a hard disk drive comprises providing a carrier that can hold at least two different printed circuit assemblies in at least two different configurations with respect to a housing, and coupling a first printed circuit assembly to the housing using the carrier, the first printed circuit assembly being coupled to the housing via toolless retention in a first orientation.

[0007] In accordance with other embodiments, a printed circuit assembly carrier comprises means for holding a printed circuit assembly capable of holding a plurality of different printed circuit assemblies in a plurality of different orientations, and means for retaining the first printed circuit assembly using toolless retention.

BRIEF DESCRIPTION OF THE DRAWINGS

[0008] Embodiments of the invention relating to both structure and method of operation, may best be understood by referring to the following description and accompanying drawings.

[0009] **FIGUREs 1A and 1B** are perspective rear and front views illustrating an embodiment of a printed circuit assembly (PCA) carrier.

[0010] **FIGUREs 2A and 2B** are perspective pictorial views showing examples of the illustrative PCA carrier embodiment installed on different types of printed circuit assemblies that are arranged in different orientations.

[0011] **FIGUREs 3A through 3F** are perspective pictorial diagrams that depict various different views of an embodiment of a hard disk drive assembly.

[0012] **FIGUREs 4A and 4B** are pictorial diagrams illustrating rear and front views of a printed circuit assembly that can be held using an embodiment of the toolless lock assembly.

[0013] **FIGURE 5** is a flow chart illustrating a method of assembling or configuring a hard disk drive.

DETAILED DESCRIPTION

[0014] A carrier **100** is configured to hold multiple printed circuit assemblies in multiple different orientations to support operability of one or more electronic devices configured for multiple uses. In a particular embodiment, the carrier **100** is used to support manageability of hard disk drives configured for simplex or duplex modes as shown in **FIGUREs 2A and 2B**.

[0015] For example, the carrier **100** enables toolless installation of a manageability printed circuit assembly **304** into the carrier **100** and toolless installation to the rear of a hard disk drive printed circuit assembly **308** as shown in **FIGURE 3A**. The carrier **100**

can also supply a cable connector retention feature 120, for example for usage in securing a small computer systems interface (SCSI) cable connection. In the illustrative embodiment, the cable is separate from the connector as shown in **FIGURE 1A**.

[0016] For system configuration in a duplex mode, the carrier 100 is installed on the side of the main hard disk drive printed circuit assembly 308 as shown in **FIGURE 3B** with a duplex printed circuit assembly 306. The duplex printed circuit assembly 306 snaps into the same features as the management printed circuit assembly 304 as shown in **FIGURE 1B** and the carrier 100 can be installed without using tools on the side of the hard disk drive housing or cage 302. In the illustrative configuration, the carrier 100 also prevents the duplex printed circuit assembly 306 from physically contacting sheet metal of the hard disk drive cage 302, possibly resulting in electrical short-circuiting or damage to the printed circuit assembly 304, 306, and/or 308.

[0017] The illustrative carrier 100 and design configuration of an electronic device 300 enables a single part, for example a plastic part, to be molded, configured, and applied to support multiple different printed circuit assemblies installed in different orientations. The carrier 100 is toolless and therefore does not require screws or other fasteners for installation of a printed circuit assembly into the carrier 100 or when the carrier assembly is installed into an electronic device or system. The carrier 100 can also include a cable connector retention feature 120, for example for usage in the management printed circuit assembly configuration to prevent cable connections, such as SCSI cable connections, from loosening or separating during reliability testing and after transportation to customer sites.

[0018] The illustrative carrier 100 and design configuration enables multiple different printed circuit assemblies to be installed into a space-constrained area within an electronic device or system, and includes features, such as cable retention features 120, that facilitate passing of qualification testing and improve user interfacing for installation and removal of the printed circuit assemblies within the system.

[0019] The carrier **100** and design configuration enable disassembly of the carrier **100** from a printed circuit assembly to support a capability for recycling and to address environmental concerns and regulations.

[0020] The capability for toolless connection in an electronic device eliminates usage of screws or other hardware, thereby reducing the number of components to be managed, installed, and maintained. The illustrative carrier **100** and design configuration also eliminates usage of retention features on cable connectors that would otherwise increase the amount of physical space consumed within an area that is typically highly constrained.

[0021] Referring to **FIGUREs 1A and 1B**, perspective rear and front views show an embodiment of a printed circuit assembly (PCA) carrier **100**. The PCA carrier **100** comprises a carrier frame **102** that is configured to hold a selected printed circuit assembly of at least two different printed circuit assemblies in at least two different orientations. A first toolless retention feature **104** is coupled to a first surface **106** of the carrier frame **102** and is configured to retain the selected printed circuit assembly. A second toolless retention feature **108** is coupled to a second surface **110** of the carrier frame **102** and is configured to secure the carrier frame **102** in at least one of the orientations.

[0022] In the illustrative PCA carrier **100**, the carrier frame **102** is constructed from molded plastic material, for example polycarbonate, and the first **104** and second **108** toolless retention features are plastic snap features that are molded onto and extend from the frame **102**. A specific plastic material that can be used in polycarbonate, GE Lexan HF1110, Color 701 Black, from GE Plastics of Pittsfield, Massachusetts. Many other materials may be appropriate.

[0023] In some embodiments, the carrier frame **102** comprises a first member **112** having parallel opposing planar surfaces including an interior planar surface **106** and an exterior planar surface **114**. The interior planar surface **106** is shown as the surface coupled to the first toolless retention feature **104**. The interior planar surface **106** is configured to receive and retain the selected printed circuit assembly. The illustrative

carrier frame **102** also comprises a second member **116** coupled at an end of the first member **112** at an angle that is substantially perpendicular to the first member **112**. The substantially perpendicular angle between the first **112** and second **116** members can have a wide range of variability and is configured to assist in securing a printed circuit assembly within the carrier **100** and to enable placement and location of the carrier **100** and secured printed circuit assembly in the plurality of possible orientations. A substantially perpendicular angle between first **112** and second **116** members enables carriers **100** to secure different printed circuit assemblies in perpendicular orientations.

[0024] In the illustrative embodiment, the second member **116** extends beyond the interior planar surface **106** to the second surface **110** that couples to the second toolless retention feature **108**.

[0025] In some embodiments, the PCA carrier **100** further comprises a cable retention feature **120** coupled to the carrier frame **102**. The cable retention feature **120** is used to secure one or more cables that connect devices in a system. In the illustrative example, the cable retention feature **120** is a plastic extrusion or other feature molded onto the carrier frame **102**.

[0026] Referring to **FIGURES 2A** and **2B** are perspective pictorial views showing examples of the illustrative PCA carrier embodiment **100** installed on respective first **200** and second **202** types of printed circuit assemblies that are arranged in two different orientations. In the illustrative embodiment, the first printed circuit assembly **200** is a management printed circuit assembly for usage with a hard disk drive printed circuit assembly in either simplex or duplex configurations. The second printed circuit assembly **202** is a duplex printed circuit assembly for usage with the hard disk drive printed circuit assembly in the duplex configuration.

[0027] Referring to **FIGURES 3A** through **3F**, various perspective pictorial diagrams depict multiple different views of an embodiment of a hard disk drive assembly **300**. **FIGURE 3A** illustrates a perspective view from a right rear angle. **FIGURE 3B** depicts a similar view from a left rear angle. **FIGURE 3C** shows the hard disk drive assembly **300** from a more direct rear view. **FIGURE 3D** illustrates the hard drive **300** in a

perspective right side view. **FIGURE 3E** shows the drive assembly **300** from the right front perspective view. **FIGURE 3F** illustrates a left side view of the rear portion of the drive assembly **300**. The hard disk drive assembly **300** comprises a hard disk drive housing **302** and first **304** and second **306** printed circuit assemblies of respective first and second types that are coupled to the housing **302**. Identical printed circuit assembly carriers **100** are capable of coupling the first and second printed circuit assemblies to the housing. The carriers **100** couple the printed circuit assemblies **304** and **306** of different types to the housing **302** in different orientations via toolless retention features **104** and **108**.

[0028] In some embodiments, the hard disk drive assembly **300** further comprises a third printed circuit assembly **308** that can be coupled to a side of the hard disk drive housing **302**. In the illustrative embodiment, the third printed circuit assembly **308** is substantially planar and has a first planar side that can be coupled to the housing **302** and a second opposing planar side. One of the printed circuit assembly carriers **100** couples the first printed circuit assembly **304** to the second planar side of the third printed circuit assembly **308**. Another printed circuit assembly carrier **100** couples the second printed circuit assembly **306** substantially perpendicular to the third printed circuit assembly **308**.

[0029] In the illustrative hard disk drive assembly **300**, the second printed circuit assembly **306** and the second of the printed circuit assembly carriers **100** are implemented for usage of the hard disk drive assembly **300** in a duplex configuration. In the particular illustrative example embodiment, the first printed circuit assembly **304** is a management printed circuit assembly, the second printed circuit assembly **306** is a duplex printed circuit assembly, and the third printed circuit assembly **308** is a hard disk drive printed circuit assembly.

[0030] The cable retention feature **120** formed on the carrier **100** is configured to secure the connector of cables, such as SCSI cables routed to the hard disk drive assembly **300**. In a particular example, the cable retention feature **120** can be used to secure a main Small Computer Systems Interface (SCSI) cable that is attached to the hard disk drive assembly **300**.

[0031] Referring to **FIGURES 4A and 4B**, pictorial diagrams illustrating rear and front views of a printed circuit assembly **308** that can be held using an embodiment of the toolless PCA carrier **100**. The toolless PCA carrier **100** is shown holding the management printed circuit assembly **304** and the duplex printed circuit assembly **306** in combination with the printed circuit assembly **308**. Connectors **400** mounted on the printed circuit assembly **308** receive a cable **402** that supplies signal connections to an electronic device.

[0032] Referring to **FIGURE 5**, a flow chart illustrates a method of assembling or configuring a hard disk drive **500** that comprises providing a carrier **502** that can hold at least two different printed circuit assemblies in at least two different configurations with respect to a hard disk drive housing. The method further includes coupling a first printed circuit assembly to the hard disk drive housing **504** using the carrier. The first printed circuit assembly couples to the housing using toolless retention with the first printed circuit assembly arranged in a first orientation.

[0033] The method further comprises coupling a second printed circuit assembly to a surface of the hard disk drive housing **506** and coupling the first printed circuit assembly to the second printed circuit assembly using the carrier **508**. The first printed circuit assembly is coupled to the second printed circuit assembly **506** using toolless retention in a first orientation. In an illustrative system, the first printed circuit assembly snaps onto the second printed circuit assembly using snap features that are molded onto the carrier.

[0034] In some embodiments, the second printed circuit assembly has an essentially planar structure and the hard disk drive housing has an essentially planar surface for attaching the second printed circuit assembly. In the illustrative embodiment, the second printed circuit assembly attaches to the hard disk drive housing in a toolless manner. For example, the hard disk drive housing can have tabs that extend from the housing and insert into apertures in the second printed circuit assembly. Other embodiments can use other types of toolless interconnections between the second printed circuit assembly and the housing. In still other embodiments, the second printed circuit assembly can attach to the housing using screws or other hardware. The first printed circuit assembly couples to the second printed circuit assembly via toolless retention in a first orientation in which the

first printed circuit assembly aligned essentially parallel to the planar surface of the housing and the essentially planar form of the second printed circuit assembly.

[0035] In some hard disk drive configurations, the method further comprises the optional action of coupling a third printed circuit assembly to the second printed circuit assembly using a second carrier **510**. The third printed circuit assembly can be coupled to the second printed circuit assembly via toolless retention with the third printed circuit assembly and carrier arranged in a second orientation that differs from the orientation of the first printed circuit assembly. In the illustrative hard disk drive assembly, the third printed circuit assembly snaps into the carrier using snap features that are molded into the carrier. The third printed circuit assembly and second printed circuit assembly have connectors that are mated during assembly to secure the assemblies using toolless retention. In a specific embodiment, the third printed circuit assembly can be aligned essentially perpendicular to the second printed circuit assembly.

[0036] In some configurations, the method further comprises the optional action of retaining cables **512** that extend between the hard disk drive housing and the first printed circuit card assembly within a cable retention feature of the carrier.

[0037] In a specific illustrative embodiment, the first printed circuit assembly may be a manageability printed circuit assembly (PCA) and the second printed circuit assembly a main hard disk drive PCA with the main hard disk drive PCA coupled directly to the hard disk drive housing, chassis, or cage either using toolless connections or via tooled connections using attachment hardware such as screws. The manageability PCA can be oriented in a plane that is essentially parallel to the hard disk drive PCA and attached to the hard disk drive PCA using a carrier and secured using a toolless connection. The third printed circuit assembly can be a duplex PCA oriented essentially perpendicular to the manageability PCA and the hard disk drive PCA, for example mounted adjacent to another side of the hard drive housing. The duplex PCA can be mounted onto a second carrier that separates and insulates the duplex PCA from the hard drive housing. The duplex PCA can be secured to the hard disk drive PCA, for example, by mating connectors.

[0038] In an alternative embodiment, functionality of the hard disk drive PCA can be implemented on the manageability PCA and/or the duplex PCA so that the hard disk drive PCA can be omitted. For example, the duplex PCA can be attached to the manageability PCA by toolless coupling using a carrier.

[0039] While the present disclosure describes various embodiments, these embodiments are to be understood as illustrative and do not limit the claim scope. Many variations, modifications, additions and improvements of the described embodiments are possible. For example, those having ordinary skill in the art will readily implement the steps necessary to provide the structures and methods disclosed herein, and will understand that the process parameters, materials, and dimensions are given by way of example only. The parameters, materials, and dimensions can be varied to achieve the desired structure as well as modifications, which are within the scope of the claims. Variations and modifications of the embodiments disclosed herein may also be made while remaining within the scope of the following claims. For example, the specific examples of electronic devices described herein are hard drives or hard disk drives. The disclosed systems, devices, and methods may be used with any suitable electronic devices.